

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: PROCESS FOR FORMING A BURIED CAVITY
IN A SEMICONDUCTOR MATERIAL WAFER
AND A BURIED CAVITY

Attorney Docket Number:: 854063.618D1

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 3

Small Entity?:: No

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Italy
Status:: Full Capacity
Given Name:: Pietro
Middle Name::
Family Name:: Erratico
Name Suffix::
City of Residence:: Milano
State or Province of Residence::
Country of Residence:: Italy
Street of mailing address:: Via Sismondi, 6
City of mailing address:: Milano
State or Province of mailing address::
Country of mailing address:: Italy
Postal or Zip Code of mailing address:: 20133

Second Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Italy
Status:: Full Capacity
Given Name:: Enrico
Middle Name::
Family Name:: Sacchi
Name Suffix::
City of Residence:: Pavia
State or Province of Residence::
Country of Residence:: Italy
Street of mailing address:: Via Bixio, 9

City of mailing address:: Pavia
State or Province of mailing address::
Country of mailing address:: Italy
Postal or Zip Code of mailing address:: 27100

Third Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Italy
Status:: Full Capacity
Given Name:: Flavio
Middle Name::
Family Name:: Villa
Name Suffix::
City of Residence:: Milano
State or Province of Residence::
Country of Residence:: Italy
Street of mailing address:: Via P. Lambertenghi, 23
City of mailing address:: Milano
State or Province of mailing address::
Country of mailing address:: Italy
Postal or Zip Code of mailing address:: 20159

Fourth Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Italy
Status:: Full Capacity
Given Name:: Gabriele
Middle Name::
Family Name:: Barlocchi

Name Suffix::
City of Residence:: Cornaredo
State or Province of Residence::
Country of Residence:: Italy
Street of mailing address:: Via Lucernate, 8
City of mailing address:: Cornaredo
State or Province of mailing address::
Country of mailing address:: Italy
Postal or Zip Code of mailing address:: 20010

Fifth Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Italy
Status:: Full Capacity
Given Name:: Pietro
Middle Name::
Family Name:: Corona
Name Suffix::
City of Residence:: Roma
State or Province of Residence::
Country of Residence:: Italy
Street of mailing address:: Via Dei Volsci, 44
City of mailing address:: Roma
State or Province of mailing address::
Country of mailing address:: Italy
Postal or Zip Code of mailing address:: 00185

Correspondence InformationCorrespondence Customer Number :: **00500****Representative Information**

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	Division of	09/797,206	02/27/01

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Europe	00830148.3	02/29/00	Yes

Assignee Information

Assignee name::	STMicroelectronics S.r.l.
Street of mailing address::	Via C. Olivetti, 2
City of mailing address::	Agrate Brianza
State or Province of mailing address::	
Country of mailing address::	Italy
Postal or Zip Code of mailing address::	20041

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